

PRODUCT FEATURES

- High level of integration
- IGBT CHIP(1700V Trench+Field Stop technology)
- Low saturation voltage and positive temperature coefficient

- Fast switching and short tail current

- Free wheeling diodes with fast and soft reverse recovery
- Industry standard package with insulated copper base plate and soldering pins for PCB mounting
- Temperature sense included



Rectifier+Inverter

APPLICATIONS

- AC motor control
- Motion/servo control
- Inverter and power supplies

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS($T_C=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J=25^{\circ}\text{C}$	1700	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C=25^{\circ}\text{C}, T_{Jmax}=175^{\circ}\text{C}$	114	A
		$T_C=100^{\circ}\text{C}, T_{Jmax}=175^{\circ}\text{C}$	75	
I_{CM}	Repetitive Peak Collector Current	$tp=1\text{ms}$	150	
P_{tot} 1	Power Dissipation Per IGBT	$T_C=25^{\circ}\text{C}, T_{Jmax}=175^{\circ}\text{C}$	500	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS ($T_C=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^{\circ}\text{C}$	1700	V
$I_{F(AV)}$	Average Forward Current		75	A
I_{FRM}	Repetitive Peak Forward Current	$t_p=1\text{ms}$	150	

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MMG75W170HX6TC

IGBT-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=3\text{mA}$	4.8	5.8	6.6	V
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=75\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		2.15	2.4	
		$I_C=75\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		2.5		
		$I_C=75\text{A}, V_{GE}=15\text{V}, T_J=150^\circ\text{C}$		2.6		
I_{CES}	Collector Leakage Current	$V_{CE}=1700\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			1	mA
		$V_{CE}=1700\text{V}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$			10	mA
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}, T_J=25^\circ\text{C}$	-500		500	nA
R_{Gint}	Integrated Gate Resistor			5		Ω
Q_G	Gate Charge	$V_{CE}=900\text{V}, I_C=75\text{A}, V_{GE}=15\text{V}$		0.55		μC
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		7.1		nF
C_{res}	Reverse Transfer Capacitance				220	
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=900\text{V}, I_C=75\text{A}$ $R_G=7.5\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		100	ns
			$T_J=150^\circ\text{C}$		120	ns
t_r	Rise Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		65	ns
			$T_J=150^\circ\text{C}$		70	ns
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=900\text{V}, I_C=75\text{A}$ $R_G=7.5\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		400	ns
			$T_J=150^\circ\text{C}$		490	ns
t_f	Fall Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		360	ns
			$T_J=150^\circ\text{C}$		680	ns
E_{on}	Turn on Energy	$V_{CC}=900\text{V}, I_C=75\text{A}$ $R_G=7.5\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		20	mJ
			$T_J=125^\circ\text{C}$		26	mJ
			$T_J=150^\circ\text{C}$		28	mJ
E_{off}	Turn off Energy	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		11	mJ
			$T_J=125^\circ\text{C}$		17	mJ
			$T_J=150^\circ\text{C}$		20	mJ
I_{SC}	Short Circuit Current	$t_{psc} \leq 10\mu\text{s}, V_{GE}=15\text{V}$ $T_J=150^\circ\text{C}, V_{CC}=1000\text{V}$		330		A
R_{thJC}	Junction to Case Thermal Resistance (Per IGBT)				0.3	K/W

Diode-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=75\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.8	2.25	V
		$I_F=75\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.95		
		$I_F=75\text{A}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$		1.9		
t_{rr}	Reverse Recovery Time	$I_F=75\text{A}, V_R=900\text{V}$ $di_F/dt=-840\text{A}/\mu\text{s}$ $T_J=150^\circ\text{C}$		840		ns
I_{RRM}	Max. Reverse Recovery Current			80		A
Q_{RR}	Reverse Recovery Charge			27		μC
E_{rec}	Reverse Recovery Energy			18		mJ
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				0.5	K/W

MMG75W170HX6TC

Diode-RECTIFIER

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1800	V
$I_{D(AV)}$	Average Output Current(D.C.)	$T_C=100^\circ\text{C}$	75	A
I_{FSM}	Non Repetitive Surge	$T_J=150^\circ\text{C}$, $t=10\text{ms}$, 50Hz	1300	
I^2t		$T_J=150^\circ\text{C}$, $t=10\text{ms}$, 50Hz	8450	A^2s

Diode-RECTIFIER

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=75\text{A}$, $T_J=25^\circ\text{C}$		1	1.3	V
		$I_F=75\text{A}$, $T_J=150^\circ\text{C}$		0.87		V
I_R	Reverse Leakage Current	$V_R=1800\text{V}$, $T_J=25^\circ\text{C}$			500	μA
		$V_R=1800\text{V}$, $T_J=150^\circ\text{C}$			10	mA
V_{TO}	For power loss calculations only, $T_J = 150^\circ\text{C}$				0.85	V
r_T					3.2	m Ω
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				0.27	K/W

NTC CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
R_{25}	Resistance	$T_C=25^\circ\text{C}$		5		k Ω
$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 \text{ K}))]$			3375		K

MMG75W170HX6TC

MODULE CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
T_{Jmax}	Max. Junction Temperature	Inverter	175	°C
		Rectifier	150	
T_{Jop}	Operating Temperature		-40~150	
T_{stg}	Storage Temperature		-40~125	
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	4000	V
Md	Mounting Torque	Recommended (M5)	2.5~5	Nm
Weight			308	g

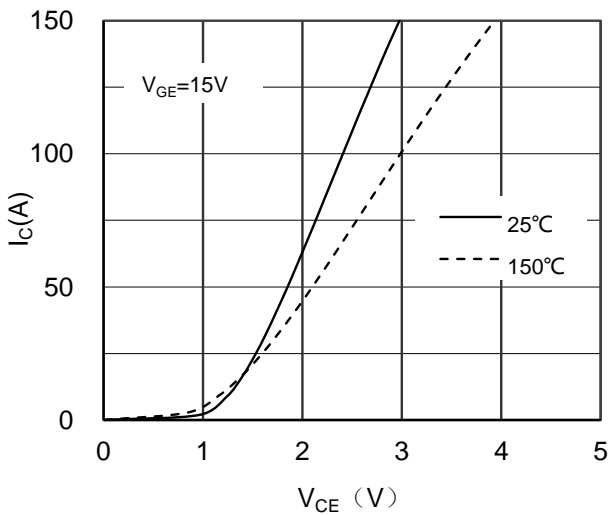


Figure 1. Typical Output Characteristics IGBT-inverter

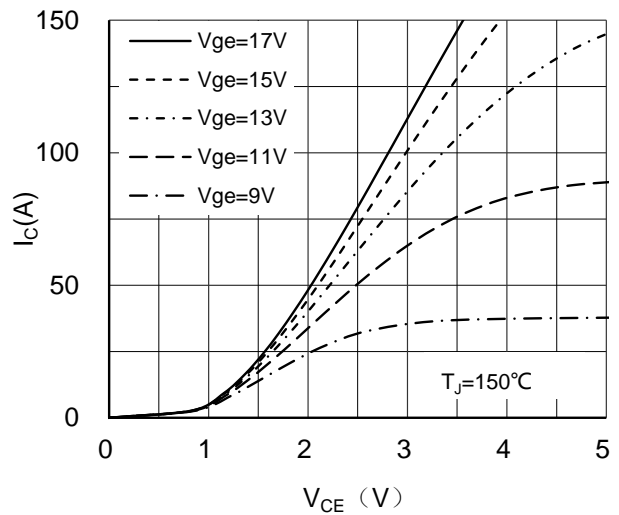


Figure 2. Typical Output Characteristics IGBT-inverter

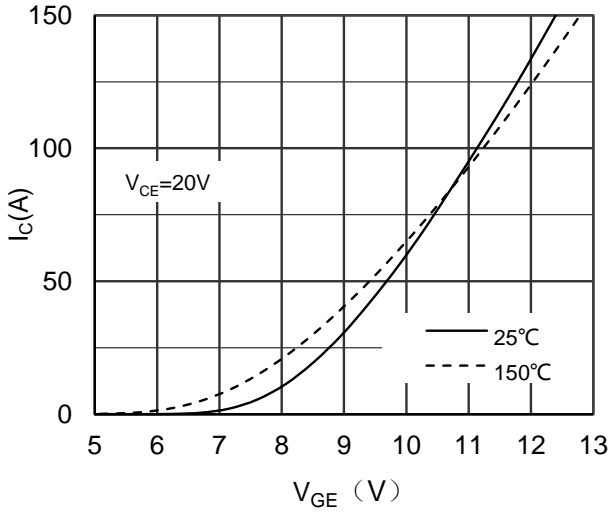


Figure 3. Typical Transfer characteristics IGBT-inverter

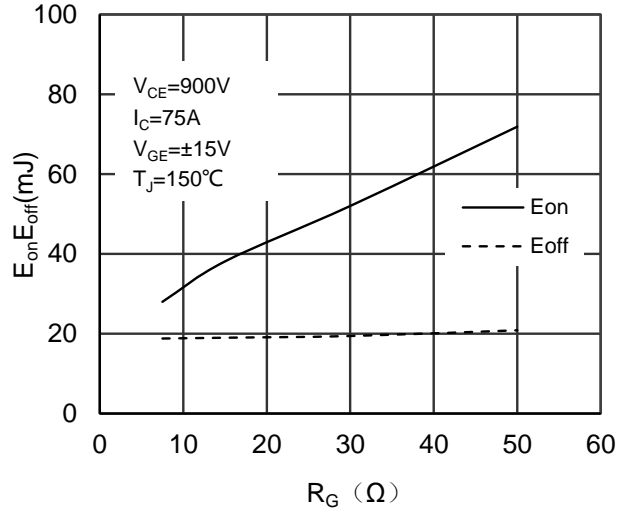


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

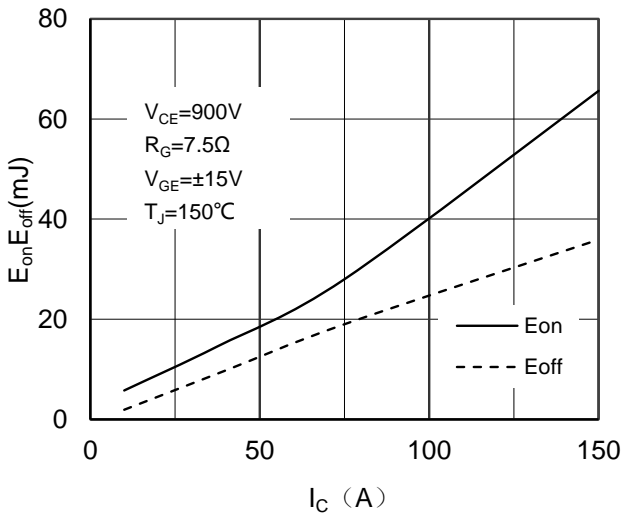


Figure 5. Switching Energy vs Collector Current IGBT-inverter

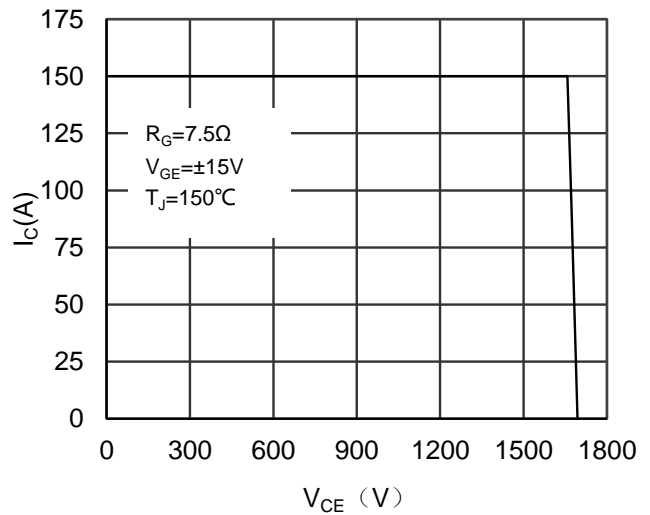


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

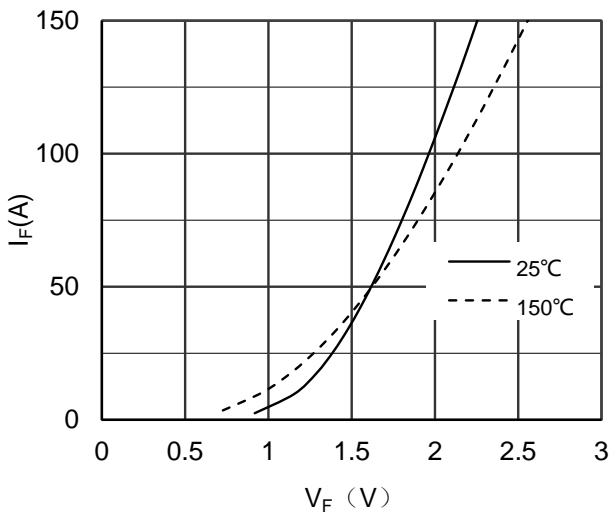


Figure 7. Diode Forward Characteristics Diode -inverter

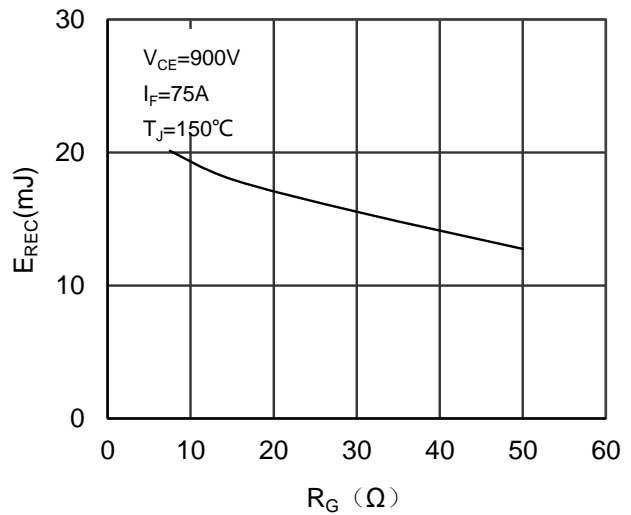


Figure 8. Switching Energy vs Gate Resistor Diode -inverter

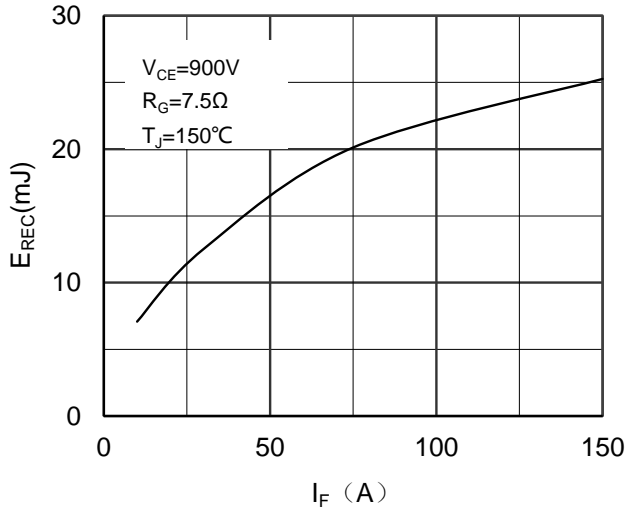


Figure 9. Switching Energy vs Forward Current Diode- rectifier

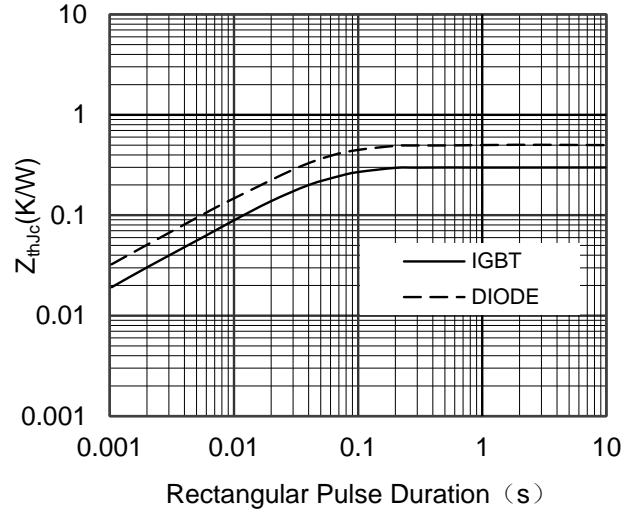


Figure 10. Transient Thermal Impedance of Diode and IGBT-inverter

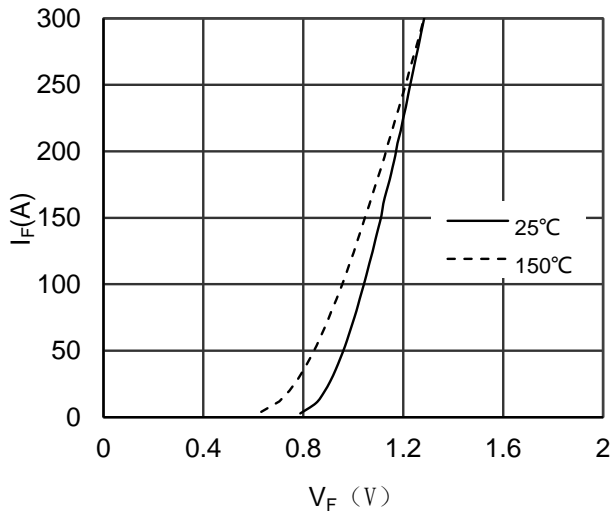


Figure 11. Diode Forward Characteristics Diode- rectifier

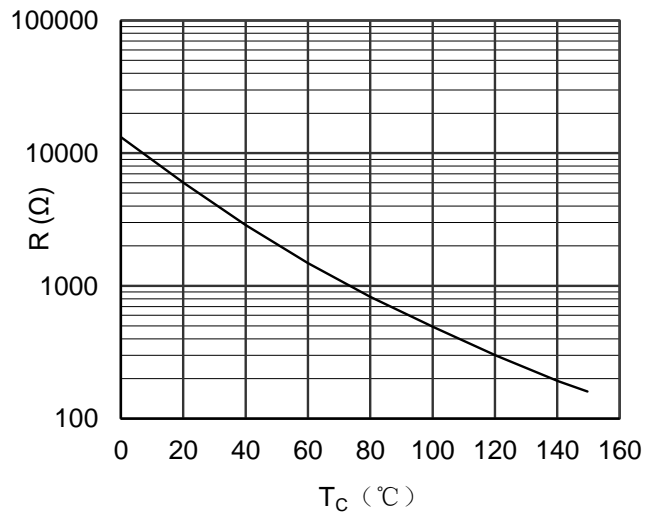
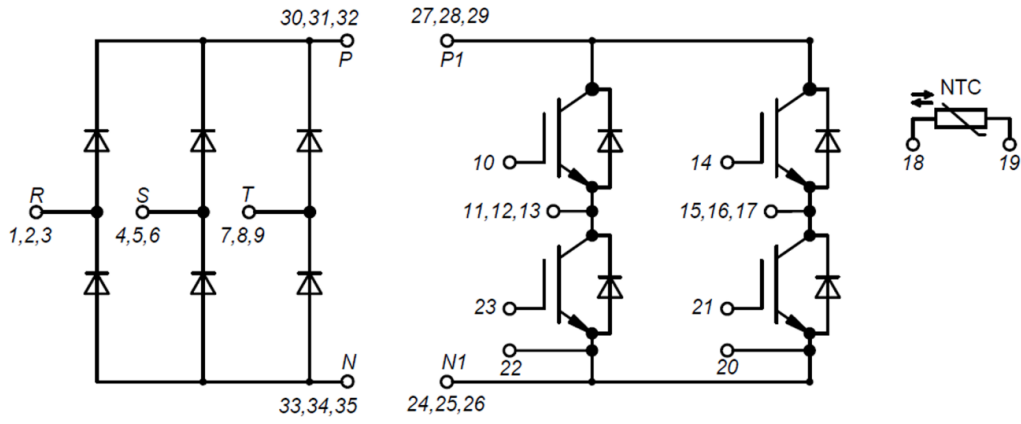


Figure 12. NTC Characteristics

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Detail D
Scale 5:1

